



PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q79041

Youichi KUKIMOTO, et al.

Appln. No.: 10/765,931

Group Art Unit: 2823

Confirmation No.: 1863

Examiner: Khiem D. Nguyen

Filed: January 29, 2004

For: SOLDER DISPOSITION METHOD AND SOLDER BUMP FORMING METHOD

DECLARATION UNDER 37 C.F.R. § 1.132

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

The undersigned, on behalf of the petitioner, HARIMA CHEMICALS, INC., represents that the petitioner, HARIMA CHEMICALS, INC. is the owner of the entire right, title and interest of U.S. Application No. 10/342,210, filed on January 15, 2003 for SOLDER PRECIPITATING COMPOSITION by virtue of an Assignment from all of the inventors thereof executed on November 22 and December 11, 2002, recorded on January 15, 2003, at Reel 013661, Frame 0629, now issued as U.S. Patent 6,923,875.

The petitioner, HARIMA CHEMICALS, INC. is also the owner of the entire right, title and interest in the above-captioned U.S. Application No. 10/765,931, filed on January 29, 2004, by virtue of an Assignment from all of the inventors thereof executed on December 8, 2003, recorded on January 29, 2004, at Reel 014944, Frame 0274.

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DECLARATION UNDER 37 C.F.R. § 1.132
U.S. Application No.: 10/765,931

Attorney Docket Q79041

Petitioner hereby certifies that the above-mentioned Assignments have been reviewed and to the best of petitioner's knowledge and belief, title is in petitioner who is seeking to take this action.

Petitioner hereby states that the above-captioned U.S. Application No. 10/765,931 and U.S. Application No. 10/342,210 (i.e., U.S. Patent 6,923,875) were owned by, or subject to an obligation of assignment to, HARIMA CHEMICALS, INC., at the time the invention of U.S. Application No. 10/765,931 was made.

The undersigned whose signature and title appear below is empowered to act on behalf of petitioner.

I declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further, that these statements are made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001, Title 18, of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Respectfully submitted,

Date: June 2, 2006

Satomura
Name
HARIMA CHEMICALS, INC.

Title: Director, Central Research Laboratory

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